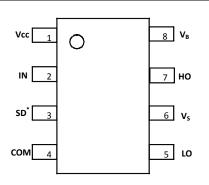


Pin Diagrams

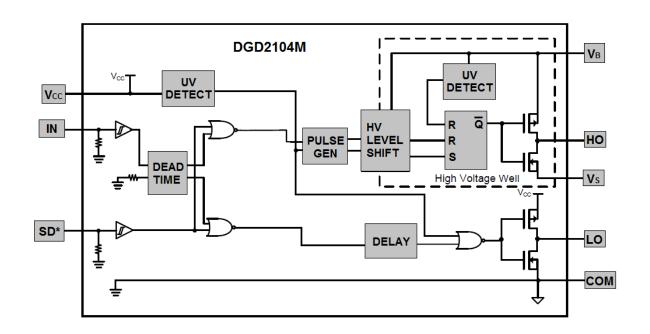




Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|----------|--|
| 1 | Vcc | Logic and Low Side Supply |
| 2 | IN | Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO |
| 3 | SD* | Logic input for Shutdown, Enabled Low |
| 4 | COM | Low-Side and Logic Return |
| 5 | LO | Low-Side Gate Drive Output |
| 6 | Vs | High-Side Floating Supply Return |
| 7 | HO | High-Side Gate Drive Output |
| 8 | VB | High-Side Floating Supply |

Functional Block Diagram





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|-----------------|---|------|
| High-Side Floating Supply Voltage | VB | -0.3 to +624 | V |
| High-Side Floating Supply Offset Voltage | Vs | V _B -24 to V _B +0.3 | V |
| High-Side Floating Output Voltage | Vно | Vs-0.3 to V _B +0.3 | V |
| Offset Supply Voltage Transient | dVs/dt | 50 | V/ns |
| Low-Side Fixed Supply Voltage | V _{CC} | -0.3 to +24 | V |
| Low-Side Output Voltage | VLO | -0.3 to Vcc+0.3 | V |
| Logic Input Voltage (IN and SD*) | VIN | -0.3 to Vcc+0.3 | V |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|--------|-------------|------|--|
| Power Dissipation Linear Derating Factor (Note 5) | PD | 0.625 | W | |
| Thermal Resistance, Junction to Ambient (Note 5) | Reja | 200 | °C/W | |
| Operating Temperature | TJ | +150 | | |
| Lead Temperature (Soldering, 10s) | TL | +300 | °C | |
| Storage Temperature Range | Tstg | -55 to +150 | | |

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

| Parameter | Symbol | Min | Max | Unit |
|--|----------------|----------|---------|------|
| High Side Floating Supply Absolute Voltage | VB | Vs + 10 | Vs + 20 | V |
| High Side Floating Supply Offset Voltage | Vs | (Note 6) | 600 | V |
| High Side Floating Output Voltage | Vно | Vs | VB | V |
| Low Side Fixed Supply Voltage | Vcc | 10 | 20 | V |
| Low Side Output Voltage | VLO | 0 | Vcc | V |
| Logic Input Voltage (IN and SD*) | VIN | 0 | 5 | V |
| Ambient Temperature | T _A | -40 | +125 | °C |

Note: 6. Logic operation for Vs of -5V to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|--|-----------------|-----|------|-----|------|---|
| Logic "1" (IN) & Logic "0" (SD*) Input Voltage | VIH | 2.5 | _ | - | V | $V_{CC} = 10V$ to $20V$ |
| Logic "0" (IN) & Logic "1" (SD*) Input Voltage | VIL | — | - | 0.8 | V | $V_{CC} = 10V$ to 20V |
| High Level Output Voltage, VBIAS - VO | Vон | — | 0.05 | 0.2 | V | $I_0 = 2mA$ |
| Low Level Output Voltage, Vo | Vol | — | 0.02 | 0.1 | V | $I_0 = 2mA$ |
| Offset Supply Leakage Current | I _{LK} | — | _ | 50 | μA | $V_B = V_S = 600V$ |
| Quiescent VBS Supply Current | IBSQ | — | 60 | 100 | μA | $V_{IN} = 0V \text{ or } 5V$ |
| Quiescent Vcc Supply Current | Iccq1 | — | 350 | 500 | μA | $V_{IN} = 0V \text{ or } 5V, SD^* = 5V$ |
| Quiescent V _{CC} Supply Current in Shutdown | ICCQ2 | — | 590 | 750 | μA | $V_{IN} = 0V \text{ or } 5V, SD^* = 0V$ |
| Logic "1" Input Bias Current | lin+ | — | 3.0 | 10 | μA | $V_{IN} = 5V, SD^* = 0V$ |
| Logic "0" Input Bias Current | lin- | — | - | 5.0 | μA | $V_{IN} = 0V, SD^* = 5V$ |
| Vcc Supply Undervoltage Positive Going Threshold | Vccuv+ | 8.0 | 8.9 | 9.8 | V | _ |
| Vcc Supply Undervoltage Negative Going Threshold | Vccuv- | 7.4 | 8.2 | 9.0 | V | _ |
| VBS Supply Undervoltage Positive Going Threshold | VBSUV+ | 4.5 | 5.5 | 6.5 | V | _ |
| VBS Supply Undervoltage Negative Going Threshold | VBSUV- | 4.2 | 5.2 | 6.2 | V | _ |
| Output High Short Circuit Pulsed Current | I _{O+} | 130 | 290 | _ | mA | V _O = 0V, PW ≤ 10µs |
| Output Low Short Circuit Pulsed Current | lo- | 270 | 600 | _ | mA | Vo = 15V, PW ≤ 10µs |

Notes: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|---|-----------------|-----|-----|-----|------|----------------|
| Turn-On Propagation Delay | ton | - | 680 | 820 | ns | $V_S = 0V$ |
| Turn-Off Propagation Delay | tOFF | - | 150 | 220 | ns | $V_{S} = 600V$ |
| Shutdown Propagation Delay | tsp | - | 160 | 220 | ns | — |
| Delay Matching, HO and LO Turn-On / Turn-Off | tdм | - | - | 60 | ns | — |
| Turn-On Rise Time | tR | - | 70 | 170 | ns | $V_S = 0V$ |
| Turn-Off Fall Time | t⊨ | - | 35 | 90 | ns | $V_S = 0V$ |
| Deadtime: t _{DT LO-HO} & t _{DT HO-LO} | t _{DT} | 300 | 420 | 650 | ns | — |



Timing Waveforms

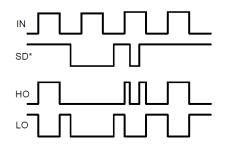


Figure 1. Input / Output Timing Diagram

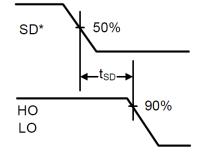
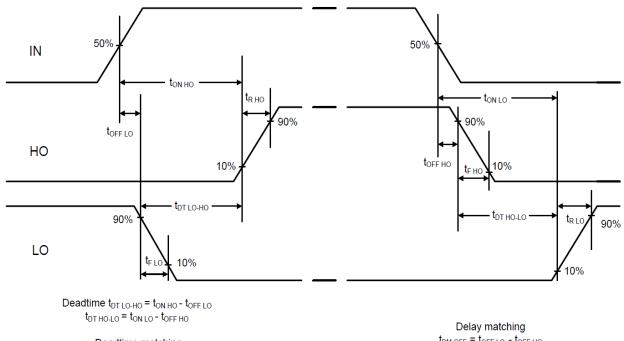


Figure 2. Shutdown Waveform Definition



Deadtime matching $t_{MDT} = t_{DT LO-HO} - t_{DT HO-LO}$ $t_{\text{DM OFF}} = t_{\text{OFF LO}} - t_{\text{OFF HO}}$ $t_{\text{DM ON}} = t_{\text{ON LO}} - t_{\text{ON HO}}$





Typical Performance Characteristics (Vcc = 15V, @TA = +25°C, unless otherwise specified.)

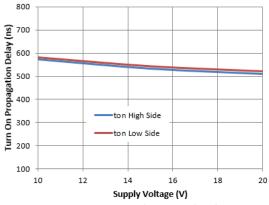


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

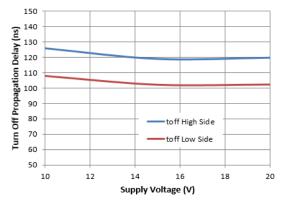
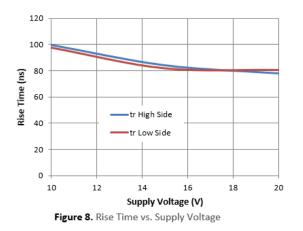


Figure 6. Turn-off Propagation Delay vs. Supply Voltage



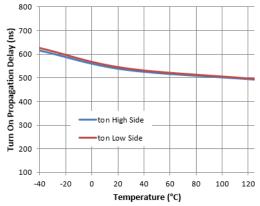


Figure 5. Turn-on Propagation Delay vs. Temperature

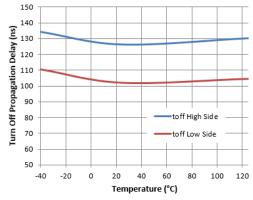
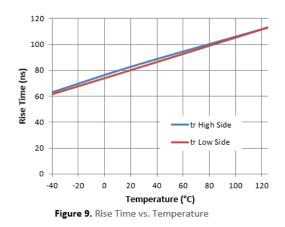
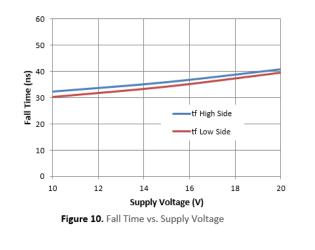


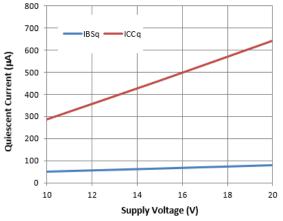
Figure 7. Turn-off Propagation Delay vs. Temperature





Typical Performance Characteristics (continued)







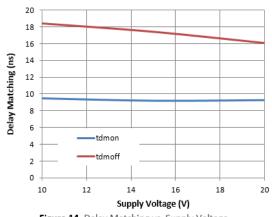
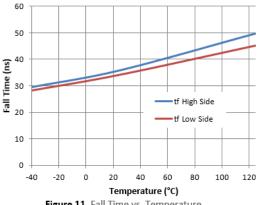
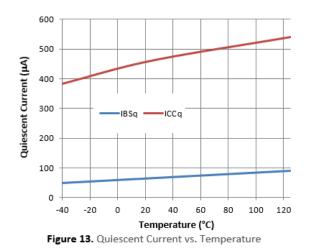


Figure 14. Delay Matching vs. Supply Voltage







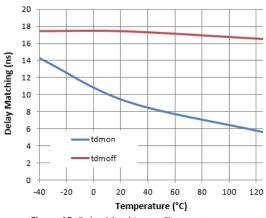


Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)

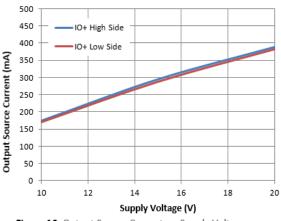


Figure 16. Output Source Current vs. Supply Voltage

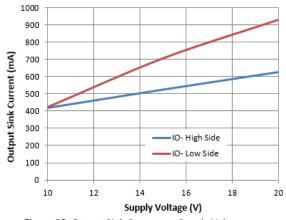


Figure 18. Output Sink Current vs. Supply Voltage

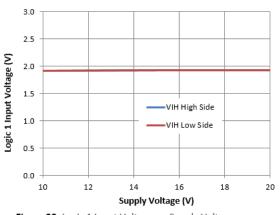
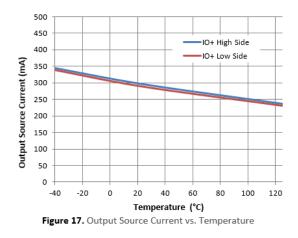
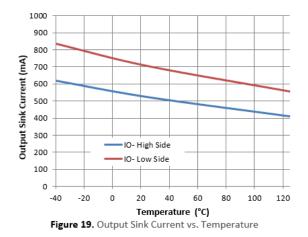


Figure 20. Logic 1 Input Voltage vs. Supply Voltage





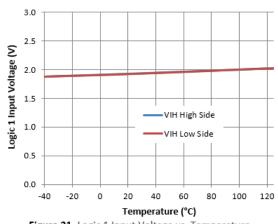
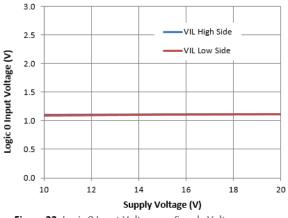


Figure 21. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (continued)





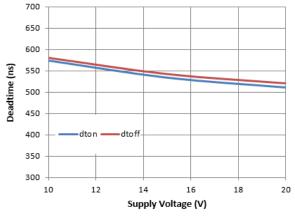
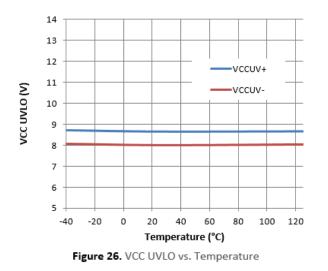


Figure 24. Deadtime vs. Supply Voltage



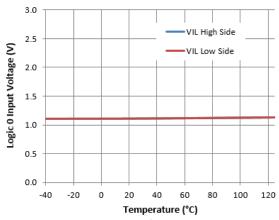


Figure 23. Logic 0 Input Voltage vs. Temperature

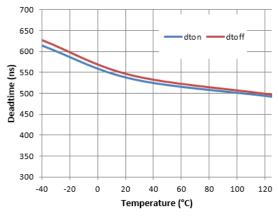


Figure 25. Deadtime vs. Temperature

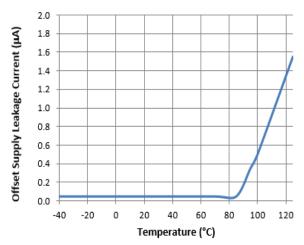
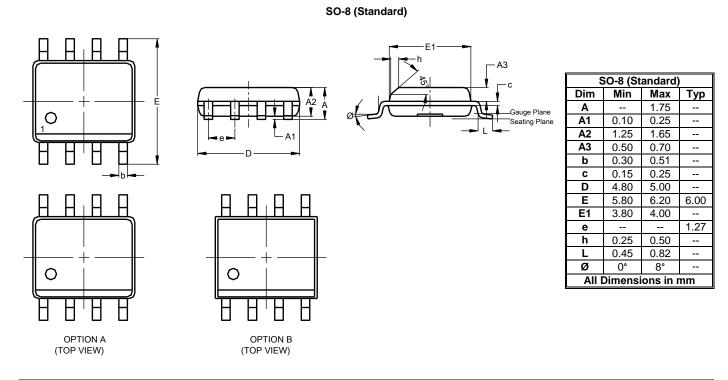


Figure 27. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

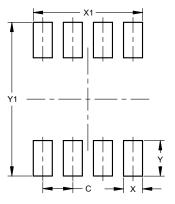
Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Standard)



| Dimensions | Value (in mm) | | | | |
|------------|---------------|--|--|--|--|
| С | 1.27 | | | | |
| Х | 0.802 | | | | |
| X1 | 4.612 | | | | |
| Y | 1.505 | | | | |
| Y1 | 6.50 | | | | |

Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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